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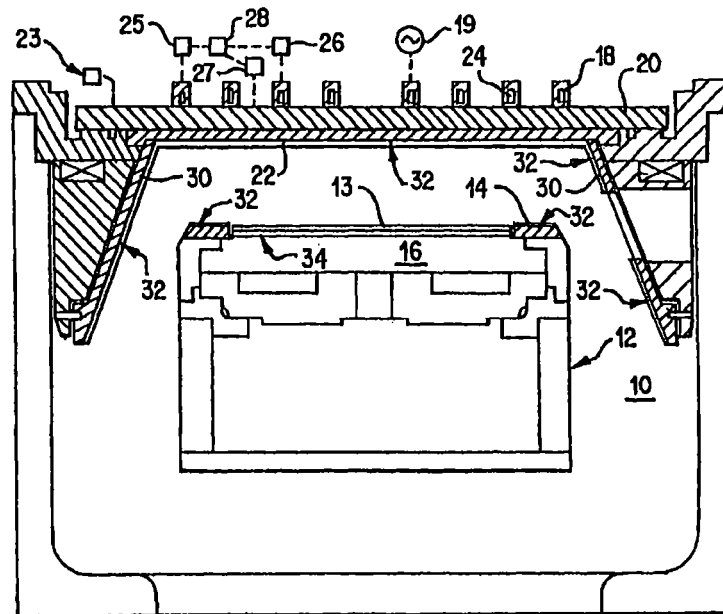
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(54) Title: THERMAL SPRAYED YTTRIA-CONTAINING COATING FOR PLASMA REACTOR



(57) Abstract: Components of semiconductor processing apparatus comprise thermal sprayed yttria-containing coatings that provide erosion, corrosion and/or corrosion-erosion resistance in plasma atmospheres. The coatings can protect substrates from physical and/or chemical attack.

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ACTION

— *before the expiration of the time limit for amending the claims and to be republished in the event of receipt of amendments*

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